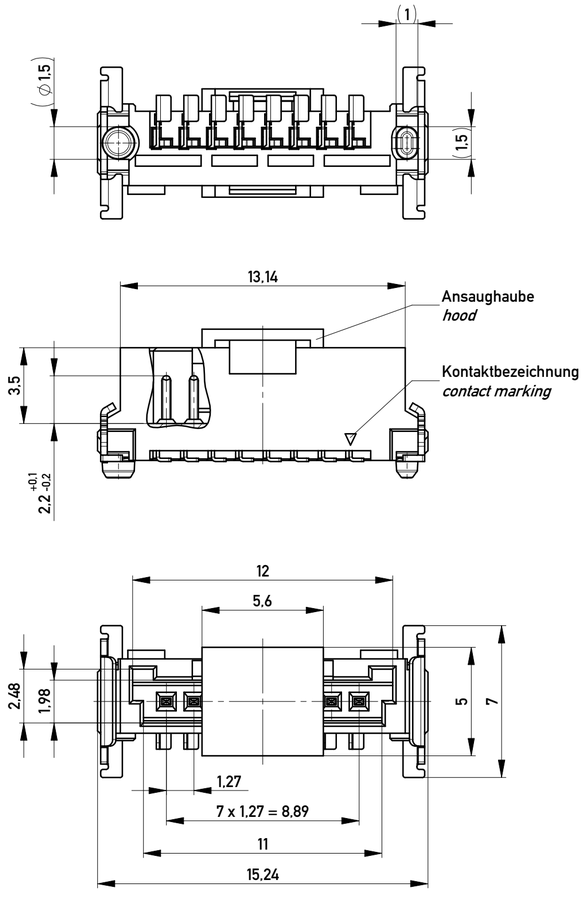
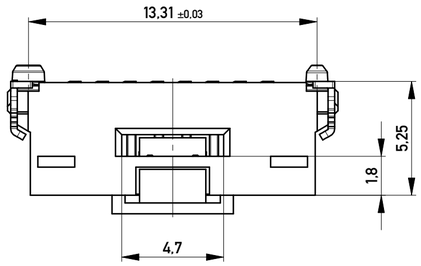
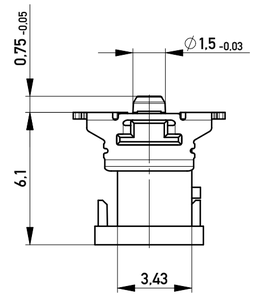
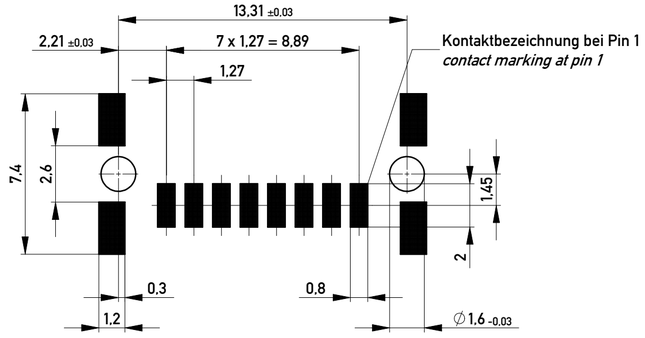


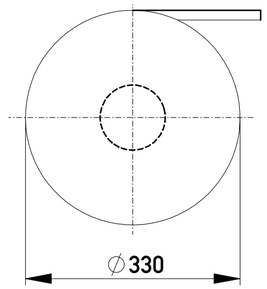




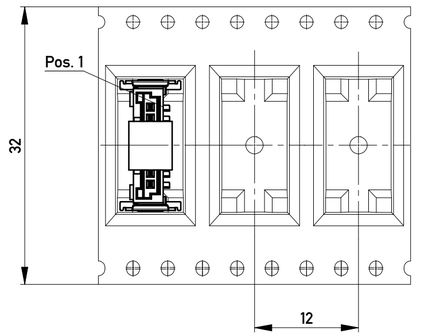
Leiterplatten-Layout für SMT
PCB-Layout for SMT



Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 650 Stück
Packaging unit: 650 pcs



Abspulrichtung - *Reel off Direction*



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Für die Anforderung nach PG 9 der LV214 (Koshiri-Sicherheit)
For the requirement of the LV214 PG 9 (Koshiri-security)

Information:

Tolerances

All Dimensions in mm

Scale 5:1

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Subject to modification without prior notice.
Drawing will not be updated.

Designation
M 1,27 SRC P, 8-polig KS
M 1,27 SRC P, 8-pin KS

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101304480001 K

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b		25.02.2016		

A2

Class SRCP